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FORM PTO-1595 04 - 30 - 20	003 EET U.S. DEPARTMENT OF COMMERCE
1/31/92	Patent and Trademark Office
To the Honorable Commissio thereof. 10243447	the attached original documents or copy
1. Name of conveying party(ies):	Name and address of receiving party(ies): Name: _Sony Corporation
HIROSHI YAMADA /2-23-23	Internal Address:
Additional name(s) of conveying party(ies)	7-35, Kitashinagawa 6-chome
attached? □ Yes ⊠ No	Shinagawa-ku, Tokyo 141, Japan
3. Nature of conveyance:	Street Address:
	O'L. Challes Time
☐ Security Agreement ☐ Change of Name ☐ Other	City:State:Zip:
Execution Date November 5, 2002	Additional Name(s) & Address(es) attached ☐ Yes ☒ No
4. Application (number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: 11/5/02	
A. Patent Application No.(s)	B: Patent No.(s) / 0/31247\$
Attorney Docket No. 09792909-5544	
Additional numbers attached? Yes No	
5. Name and address of party to whom	6. Total number of applications and patents involved 1
correspondence concerning document should be mailed:	7. Total Fee (37 CFR 3.41 \$ 40.00
SONNENSCHEIN NATH & ROSENTHAL	
P.O. Box #061080	Acct. No. 378571697401002. Form 2038 is attached for
Wacker Drive Station Sears Tower	that purpose. X Any deficiency is authorized to be charged to
Chicago, IL 60606-1080	deposit account or any additional fees
Customer ID No. 26263	8. Deposit Account Number: 19.3140
	(Attach duplicate copy of this page if paying by deposit account)
DO NOT USE THIS SPACE	
9. Statement and signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. David R. Metzger Name of Person Signing Signature December 23, 2002 Date Total number of pages 2	
Mail documents to be recorded and required cover sheet information to: Commissioner of Patents and Trademarks Box Assignments Washington, D.C. 20231+	

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Docket Number: 09792909-5544

ASSIGNMENT

A	SSIGNMENT
only one name is listed below) or a joint inventor (if plura METHOD OF FORMING METALLIC FILM AND	or, residing at the address stated next to my name, am a sole inventor (if names are listed below) of certain new and useful improvements in METHOD OF PRODUCING SEMICONDUCTOR
SYSTEM for which application for Letters Patent of the United State and addicis;	s of America was executed by me on the date indicated next to my name
Shi nagawa-Ku, Tokyo, Japan (hereinafter referenced as ASS	a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, IGNEE) is desirous of acquiring all interest in, to and under said invention, der any Letters Patent or similar legal protection which may be granted intries;
the receip and sufficiency of which are hereby acknowledge hereby as ign, sell and transfer unto the said ASSIGNEE, interest in the said invention, said application, including at Patent of he United States, and countries foreign thereto, wrights and or convention rights under the International Convention of Patents, Designs and Industrial Models, and are adheres, and to any other benefits accruing or to accrue to	the sum of One Dollar (\$1.00), and other good and valuable consideration, ed, I, as a sole or joint inventor as indicated below, by these presents do ts successors, assigns, and legal representatives, the entire right, title and my divisions and continuations thereof, and in and to any and all Letters hich may be granted for said invention, and in and to any and all priority antion for the Protection of Industrial Property, Inter-American Convention y other international agreements to which the United States of America me with respect to the filing of applications for patents or securing of d I hereby authorize and request the Commissioner of Patents to issue the e assignee of the whole right, title and interest thereto;
AS JIGNI E or its designee, as ASSIGNEE or its successor	sirable and lawful future documents, including assignments in favor of s, assigns and legal representatives may from time-to-time present to me in said invention, modifications, and improvements in said invention, untries foreign thereto;
parers for application for foreign patents, for filing subdiv	and without further remuneration, such necessary or desirable and lawful isions of said application for patent, and or, for obtaining any reissue or aforesaid invention, as the ASSIGNEE thereof shall hereafter require and
nd I further agree that ASSIGNEE will, upon i relating as said application, said invention and said Letters accessibe to me and will testify as to the same in any interest.	es request, be provided promptly with all pertinent facts and documents. Patent and legal equivalents in foreign countries as may be known and reference or litigation related thereto;
and I hereby covenant that no assignment, sale, as would conflict with this assignment and sale.	greement or encumbrance has been or will be made or entered into which
this application in the spaces that follow: Internation	onal Filing Date: <u>April 9, 2002</u>
HIROS II YAMADA	
Name of first or sole inventor	Execution date of U.S. Patent Application
Osta, Japan	
Re iden: of first or sole inventor	
Signature of first or sole inventor	. Nav. 5.2002.
Signature of first or sole inventor	Date of this assignment

RECORDED: 12/23/2002

PATENT REEL: 013996 FRAME: 0719